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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Wilbur G. Catabay and Wei-Jen Hsia

Appl. No.

09/884,736

Filed:

June 19, 2001

Title

PLASMA TREATMENT OF LOW DIELECTRIC CONSTANT DIELECTRIC MATERIAL TO FORM STRUCTURES USEFUL IN

FORMATION OF METAL INTERCONNECTS AND/OR FILLED VIAS

FOR INTEGRATED CIRCUIT STRUCTURE

Grp./ A.U.

2829

Examiner

Lisa A. Kilday

Docket No. :

00-654/RCE

EPR 29 2003

PRELIMINARY AMENDMENT

Honorable Commissioner for Patents Washington, D.C. 20231

Date: April 24, 2003

Sir:

Please amend the accompanying RCE application as follows: